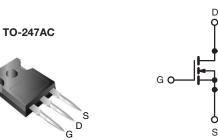


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Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	500			
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.135		
Q _g (Max.) (nC)	190			
Q _{gs} (nC)	59			
Q _{gd} (nC)	84			
Configuration	Single			



FEATURES

• Low Gate Charge $\mathbf{Q}_{\mathbf{g}}$ Results in Simple Drive Requirement



RoHS

COMPLIANT

- Improved Gate, Avalanche and Dynamic dV/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Low R_{DS(on)}
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching
- · Hard Switching and High Frequency Circuits

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFP32N50KPbF
	SiHFP32N50K-E3
SnPb	IRFP32N50K
	SiHFP32N50K

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	500	V	
Gate-Source Voltage			V _{GS}	± 30	v	
Continuous Drain Current	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	- I _D	32		
		T _C = 100 °C		20	А	
Pulsed Drain Current ^a			I _{DM}	130		
Linear Derating Factor				3.7	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	450	mJ	
Repetitive Avalanche Current ^a			I _{AR}	32	A	
Repetitive Avalanche Energy ^a			E _{AR}	46	mJ	
Maximum Power Dissipation	T _C =	25 °C	PD	460	W	
Peak Diode Recovery dV/dtc			dV/dt	13	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d	C	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. Starting T_J = 25 °C, L = 0.87 mH, R_g = 25 $\Omega,$ I_{AS} = 32 A.

c. $I_{SD} \le 32$ A, dl/dt ≤ 197 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	40	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.26	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$		500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 1 mA		0.54	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	5.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V		-	± 100	nA
	I _{DSS}	V _{DS} =	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	50	
Zero Gate Voltage Drain Current		V _{DS} = 400 \	/, V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 32 A ^b	-	0.135	0.16	Ω
Forward Transconductance	g fs	V _{DS}	V _{DS} = 50 V, I _D = 32 A		-	-	S
Dynamic					•	•	
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	5280	-	-
Output Capacitance	Coss			-	550	-	
Reverse Transfer Capacitance	C _{rss}			-	45	-	
Output Consolitance	0	V _{GS} = 0 V	V _{DS} = 1.0 V, f = 1.0 MHz	-	5630	-	- pF
Output Capacitance	C _{oss}		V _{DS} = 400 V, f = 1.0 MHz	-	155	-	
Effective Output Capacitance	Coss eff.		V _{DS} = 0 V to 400 V ^c	-	265	-	
Total Gate Charge	Qg		V _{GS} = 10 V I _D = 32 A, V _{DS} = 400 V ^b	-	-	190	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$		-	-	59	
Gate-Drain Charge	Q _{gd}				-	84	1
Turn-On Delay Time	t _{d(on)}				28	-	
Rise Time	t _r	- V _{DD} =	= 250 V, I _D = 32 A,	-	120	-	1
Turn-Off Delay Time	t _{d(off)}	Rg =	$Rg = 4.3 \Omega, V_{GS} = 10 V^{b}$		48	-	- ns
Fall Time	t _f	1		-	54	-	
Drain-Source Body Diode Characteristic	s					-	
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the		-	32	Α
Pulsed Diode Forward Current ^a	I _{SM}	p - n junction diode		-	-	130	A
Body Diode Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 32 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}			-	530	800	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = 32 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}^b$		-	9.0	13.5	μC
Body Diode Reverse Recovery Current	I _{RRM}			-	30	-	Α
Forward Turn-On Time	t _{on}	Intrinsic tu	Irn-on time is negligible (turn	on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. Pulse width $\leq 400~\mu s;$ duty cycle $\leq 2~\%.$

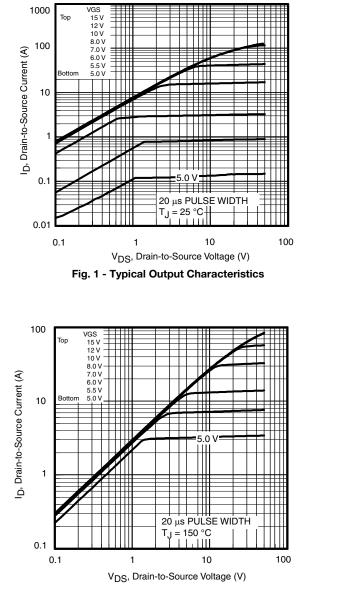
c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 2 - Typical Output Characteristics

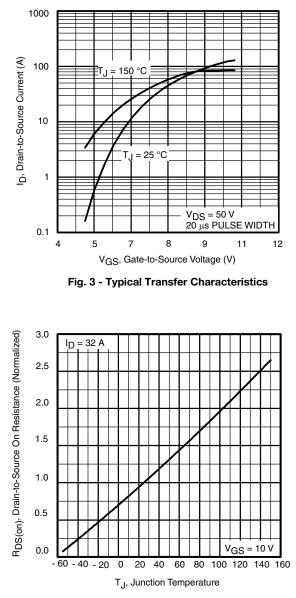


Fig. 4 - Normalized On-Resistance vs. Temperature

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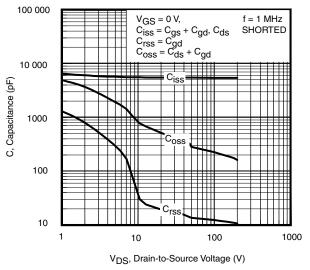


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

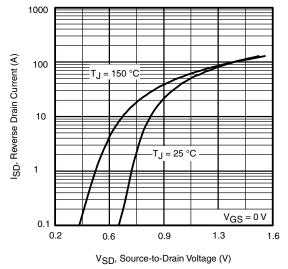


Fig. 7 - Typical Source-Drain Diode Forward Voltage

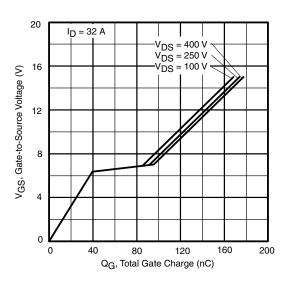


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

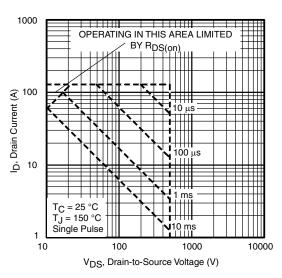


Fig. 8 - Maximum Safe Operating Area

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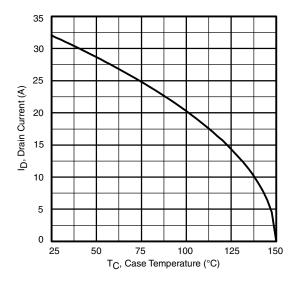


Fig. 9 - Maximum Drain Current vs. Case Temperature

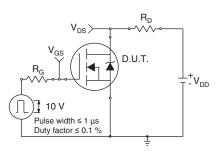


Fig. 10a - Switching Time Test Circuit

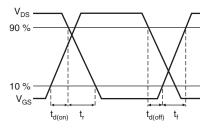


Fig. 10b - Switching Time Waveforms

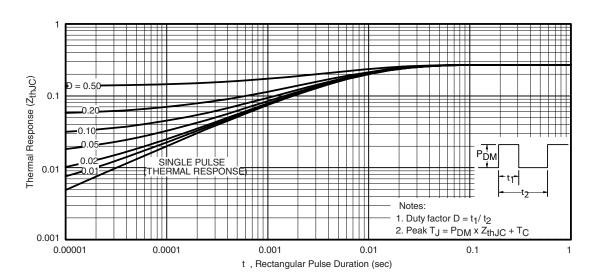


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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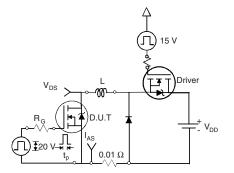


Fig. 12a - Unclamped Inductive Test Circuit

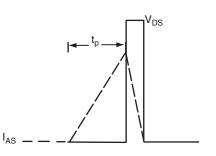


Fig. 12b - Unclamped Inductive Waveforms

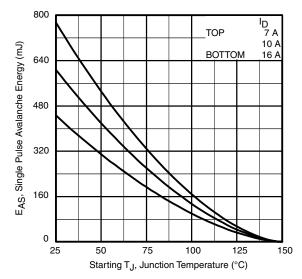


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

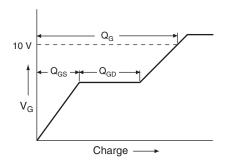


Fig. 13a - Basic Gate Charge Waveform

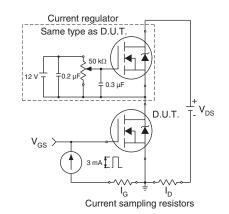


Fig. 13b - Gate Charge Test Circuit

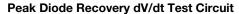
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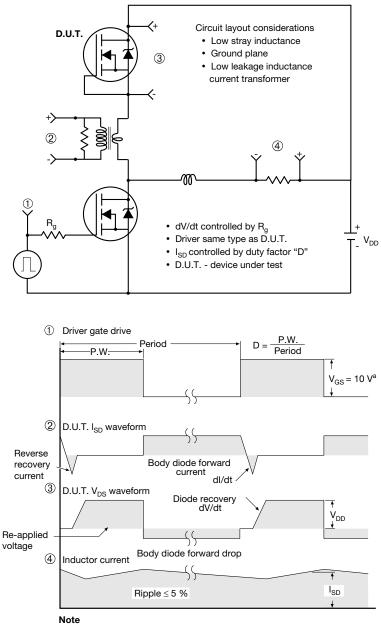
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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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